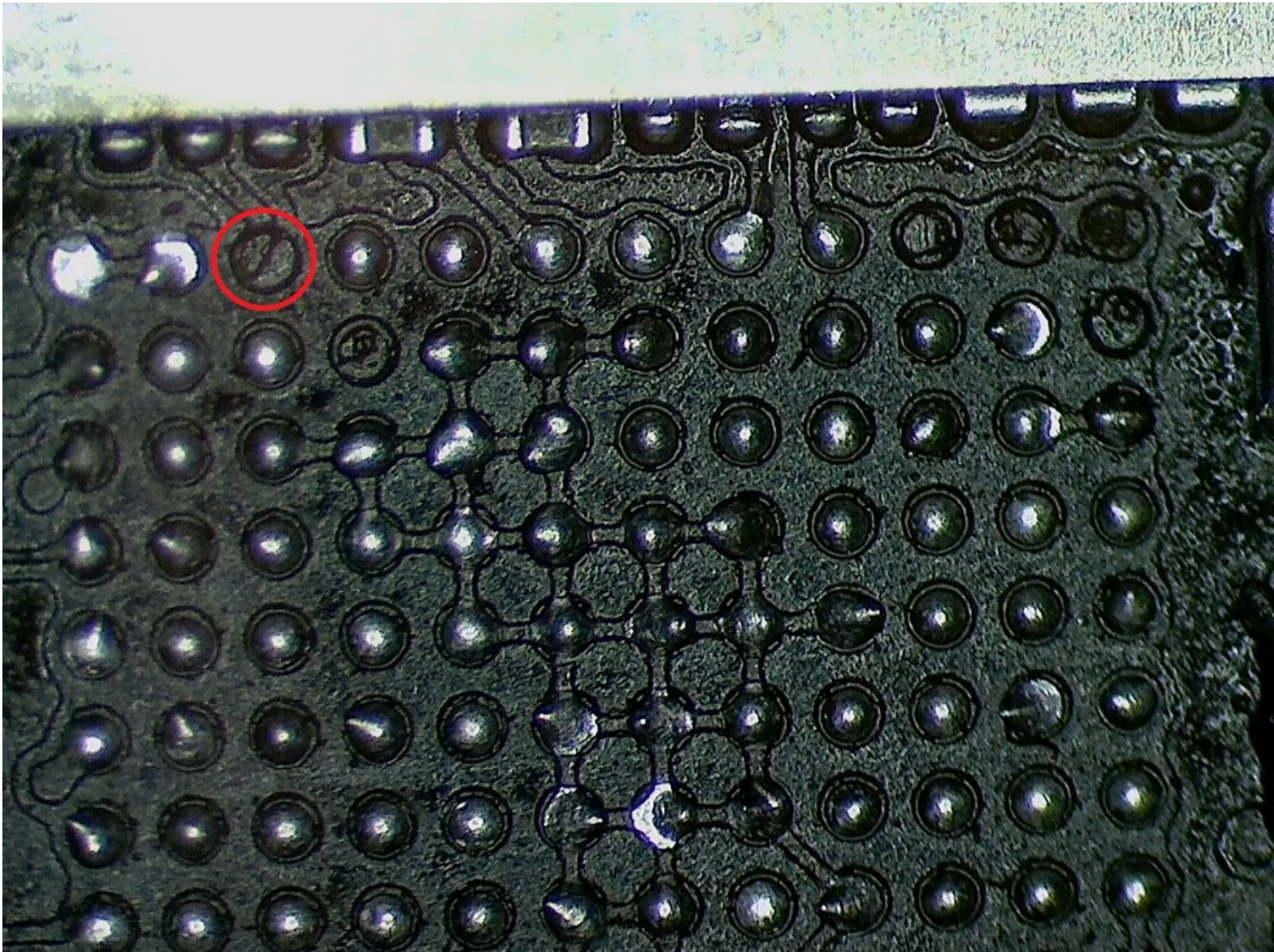




iPhone 7 - Replace U3101 Audio IC

Fix the Audio problem that affects iPhones 7 and 7 Plus with this method! Requires soldering.

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INTRODUCTION

Audio issues on iPhone 7 and iPhone 7 Plus

Since the release of the iPhone 7 and iPhone 7 Plus in 2016, we have seen many strange failures affect these models. Most of them concerned audio problems. In appearance, the phone looked in good condition, no oxidation, it was never disassembled before, no drops, no over heating and the replacement of all the usual parts, headphone jack, earphones , speakers. It did not solve not the problem.

However, there was indeed an issue, most likely linked to the logic board of the phone. Unfortunately, after a year the phones were out of warranty, so Apple no longer wanted to replace them. It was therefore necessary to call on *super-repairers*: the experts in micro welding.

An inspiration to everyone on this issue was Jessa Jones of iPad Rehab who identified the problem and came up with a solution fairly quickly. The American micro-welding community is very developed, which is not the case in France.

This guide shows how to identify and solve the problem.

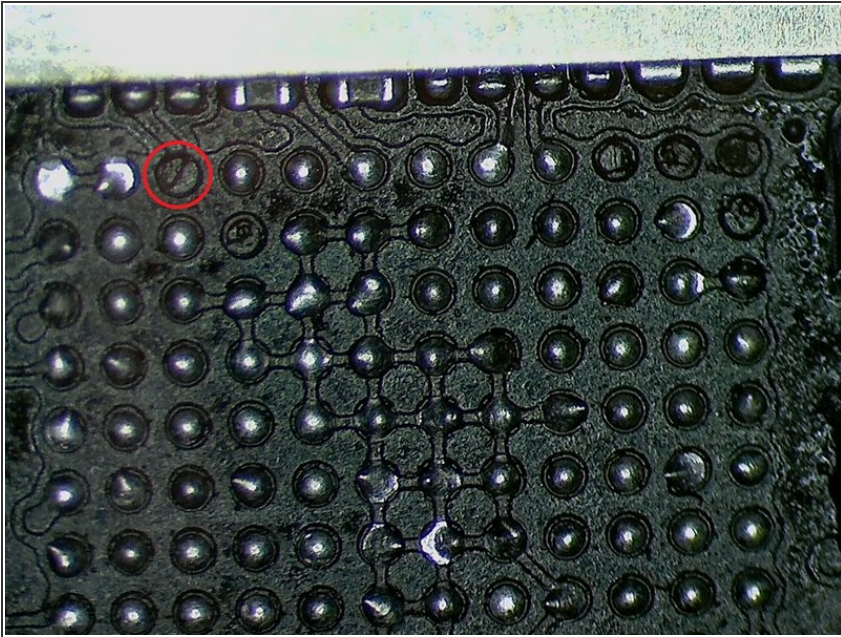
Possible symptoms:

- No audio device detected
- Micro that does not work
- Loudspeaker that does not work
- Sound of videos not working
- No sound during a call
- The phone takes a long time to start
- Headphones that do not work
- Dictaphone that does not work

The problem: the audio chip U3101

It is disconnected from the logic board. The iPhone 7's logic board may slightly be twisted and often results in a broken track.

Step 1 — Remove U3101



- Remove the chip cleanly, with hot air. On my Quick 861DE station, I use as settings 400 °C and 100L/min. For you to decide which settings you prefer, you can find the Quick 861DW on the shop.
- Clean the tracks with a soldering iron, tin and flux. I use a tip about 1mm in diameter with my JBC Nase 2C, at 360 ° C.
- Clean the map.
- Inspect the card under the microscope. We can see on the picture below that a track is missing!

Step 2 — Verification with the schema



- If we compare to the diagram on the PhoneBoard software;
- We observe very clearly that we will be able to put a wire to redo this connection, focusing on R1103.

Step 3 — Put a jumper



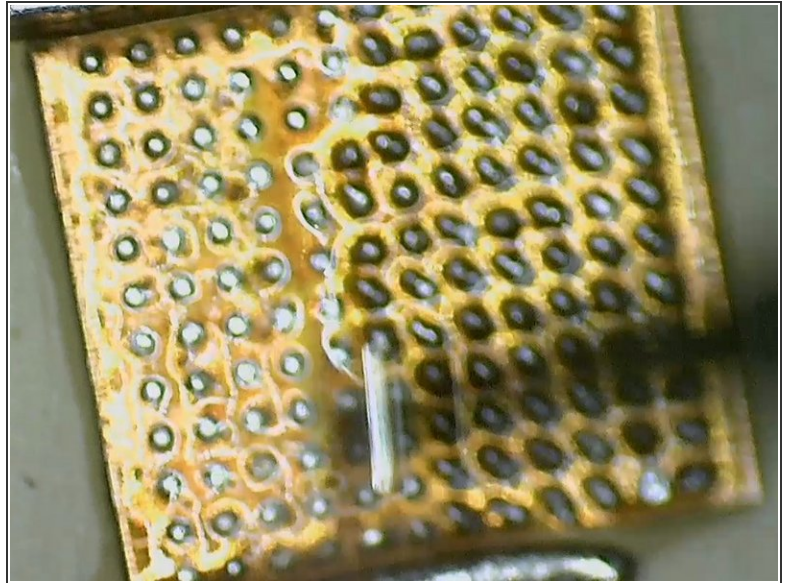
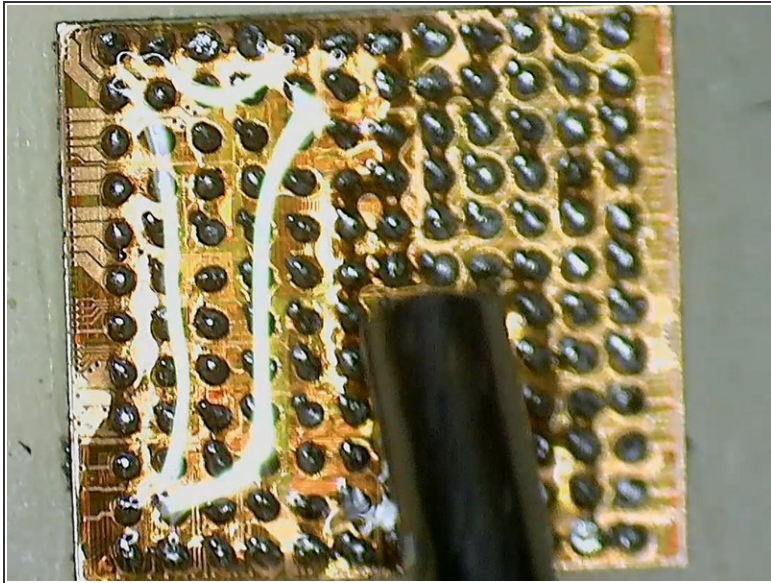
- Take copper wire diameter 0.02mm
- Apply flux and tin the wire with an iron.
- Scratch the trail from C12 to R1103.
- Etaminate this track with tin.
- Come weld one end of the wire to the resistor. I use a 0.01mm diameter tip.
- Weld the wire along the previously tinned track.
- Bring the wire into the C12 slot and try to wrap it to be sure that the chip ball will stick to it.

Step 4 — Ask all jumpers



- The procedure is the same for F12, H12, J12. A12 and B12 are grounded and are not used for U3101 operation, no need to jump.
- E12 is in contact with C1, if C1 is present no need to redo the jumper. D12, G12, J11 and A5 are connected to each other, if only one is still connected the phone can work. K12, L12, M12 are "No Connection" so no need to replace.

Step 5 — Rebillage de U3101



- Ask the flow.
- Take a soldering iron with tin at the end.
- Pass on the chip to smooth the balls.
- Clean.
- Lay a stencil of rebalancing.
- Spread some soldering paste.
- Heat with hot air to form the balls.

Step 6 — Check the balls



- Extract the chip by pushing with a thin tweezers.
- Check the size of the balls.

Step 7 — Replace the chip



- And we end up putting the chip back. Flow, position and solder with hot air.
- We let the phone cool, we go back and the problem is solved!

To reassemble your device, follow the instructions in reverse order.